



# Inductors

## RF chokes, HLBC series

**Series/Type:** B82145A

**Date:** June 2012

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**HLBC choke (High-Current Large Bobbin Core)**
**Rated inductance 100 ... 10 000  $\mu$ H**
**Rated current 110 ... 860 mA**
**Construction**

- Large ferrite drum core
- Winding: enamel copper wire
- Flame-retardant lacquer coating

**Features**

- High rated current at high inductance ratings
- Radially bent leads in bulk on request (B82145C)
- Suitable for wave soldering
- RoHS-compatible

**Applications**

- Decoupling
- Interference suppression
- For energy-saving lamps and entertainment electronics

**Terminals**

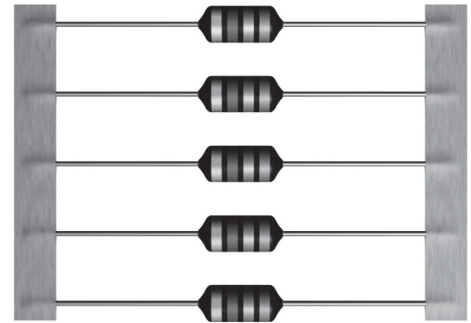
- Central axial leads (B82145A)
- Radially bent to 5mm lead spacing (B82145C)
- Base material CuAg0.1
- Electroplated with nickel and pure tin

**Marking**

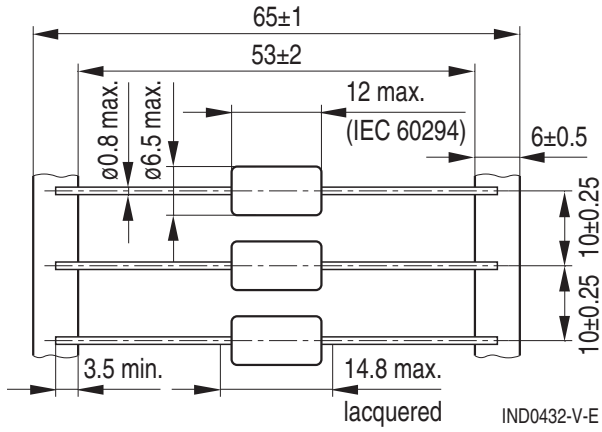
Inductance indicated by color bands to IEC 60062

**Delivery mode and packing unit**

- Taped and reeled  
Packing unit: 1250 pcs./reel
- Bulk packaging for radially bent  
Packing unit: 200 pcs./polyethylene bag

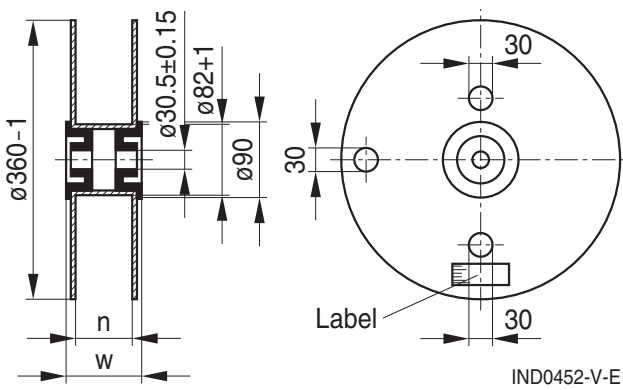


**Dimensional drawing**



Dimensions in mm  
 Minimum lead spacing 15 mm

**Packing**



Dimensions in mm

n (mm): 72 +1  
 w (mm): 84 max

**Technical data and measuring conditions**

|   |   |
|---|---|
| Rated inductance $L_R$                    | Measured with LCR meter Agilent 4284A or impedance analyzer Agilent 4294A<br>Measuring frequency: $100 \mu\text{H} < L_R \leq 4700 \mu\text{H} = 100 \text{ kHz}$<br>$L_R > 4700 \mu\text{H} = 10 \text{ kHz}$<br>Measuring current: $\leq 1 \text{ mA}$<br>Measuring temperature: $+20 \text{ }^\circ\text{C}$ |
| Q factor $Q_{\min}$                       | Measured with precision impedance analyzer Agilent 4294A, $+20 \text{ }^\circ\text{C}$  |
| Rated temperature $T_R$                   | $+40 \text{ }^\circ\text{C}$  |
| Rated current $I_R$                       | Maximum permissible DC current at rated temperature   |
| Inductance decrease $\Delta L/L_0$        | $\leq 10\%$ (referred to initial value) at $I_R$ , $+20 \text{ }^\circ\text{C}$   |
| DC resistance $R_{\max}$                  | Measured at $+20 \text{ }^\circ\text{C}$  |
| Resonance frequency $f_{\text{res},\min}$ | Measured with Agilent 4294A or 8753ES, $+20 \text{ }^\circ\text{C}$   |
| Solderability (lead-free)                 | Sn95.5Ag3.8Cu0.7: $+(245 \pm 5) \text{ }^\circ\text{C}$ , $(3 \pm 0.3) \text{ s}$<br>Wetting of soldering area $\geq 90\%$<br>(to IEC 60068-2-20, test Ta)  |
| Resistance to soldering heat              | $+(260 \pm 5) \text{ }^\circ\text{C}$ , $10 \text{ s}$ (to IEC 60068-2-20, test Tb)   |
| Tensile strength of leads                 | $\geq 20 \text{ N}$ (to IEC 60068-2-21, test Ua)  |
| Climatic category                         | 55/125/56 (to IEC 60068-1)  |
| Storage conditions                        | Mounted: $-55 \text{ }^\circ\text{C} \dots +125 \text{ }^\circ\text{C}$<br>Packaged: $-25 \text{ }^\circ\text{C} \dots +40 \text{ }^\circ\text{C}$ , $\leq 75\% \text{ RH}$   |
| Weight                                    | Approx. $1.3 \text{ g}$   |

 **Mounting information**

When bending the leads, take care that the start-of-winding areas at the face ends (protected by glue and lacquer) are not subjected to any mechanical stress.

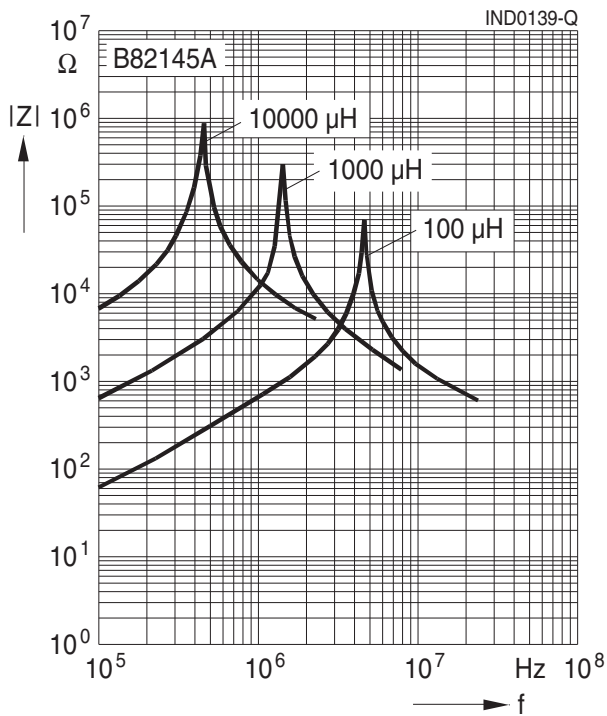
**Characteristics and ordering codes**

| $L_R$<br>$\mu\text{H}$ | Tolerance <sup>1)</sup> | $Q_{\min}$ | $f_Q$<br>MHz | $I_R$<br>mA | $R_{\max}$<br>$\Omega$ | $f_{\text{res,min}}$<br>MHz | Ordering code   |
|------------------------|-------------------------|------------|--------------|-------------|------------------------|-----------------------------|-----------------|
| 100                    | $\pm 5\% \triangle J$   | 50         | 0.796        | 860         | 0.70                   | 3.5                         | B82145A1104J000 |
| 150                    |                         | 40         | 0.796        | 770         | 0.90                   | 3.0                         | B82145A1154J000 |
| 220                    |                         | 30         | 0.796        | 690         | 1.10                   | 2.5                         | B82145A1224J000 |
| 330                    |                         | 30         | 0.796        | 630         | 1.30                   | 2.1                         | B82145A1334J000 |
| 470                    |                         | 30         | 0.796        | 510         | 1.90                   | 1.8                         | B82145A1474J000 |
| 680                    |                         | 20         | 0.796        | 440         | 2.50                   | 1.5                         | B82145A1684J000 |
| 1000                   |                         | 60         | 0.252        | 370         | 3.60                   | 1.3                         | B82145A1105J000 |
| 1500                   |                         | 60         | 0.252        | 300         | 5.40                   | 1.0                         | B82145A1155J000 |
| 2200                   |                         | 60         | 0.252        | 250         | 8.00                   | 0.8                         | B82145A1225J000 |
| 3300                   |                         | 60         | 0.252        | 200         | 12.5                   | 0.6                         | B82145A1335J000 |
| 4700                   |                         | 60         | 0.252        | 170         | 18.0                   | 0.5                         | B82145A1475J000 |
| 6800                   |                         | 60         | 0.252        | 130         | 28.5                   | 0.4                         | B82145A1685J000 |
| 10000                  |                         | 50         | 0.0796       | 110         | 35.0                   | 0.35                        | B82145A1106J000 |

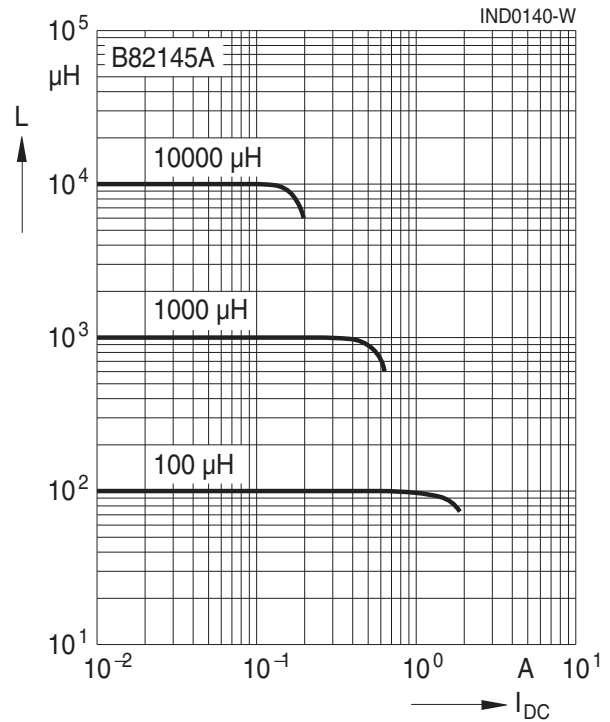
HLBC chokes with diameter 7.5 and 8.5 mm for even higher rated currents available on request.  
 HLBC chokes with temperature range up to +140 °C available on request.

1) Closer tolerances on request.

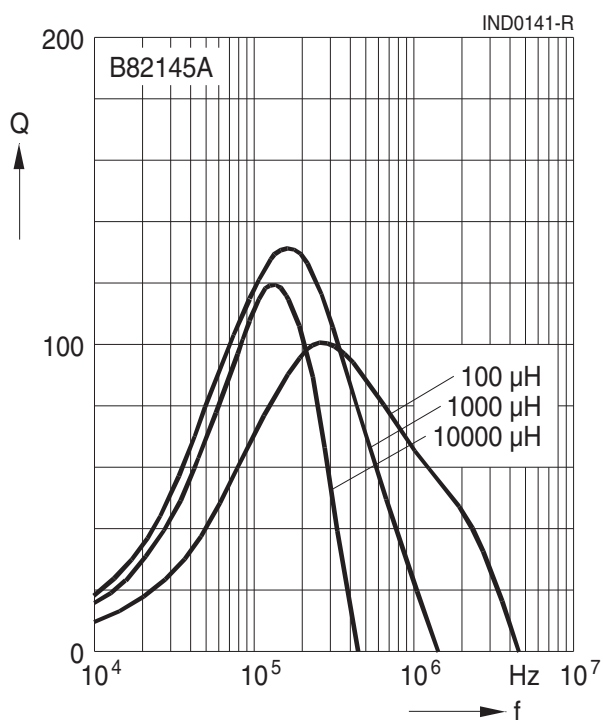
**Impedance  $|Z|$  versus frequency  $f$**   
 measured with impedance analyzer Agilent 4294A or S-parameter network analyzer Agilent 8753ES, typical values at +20 °C



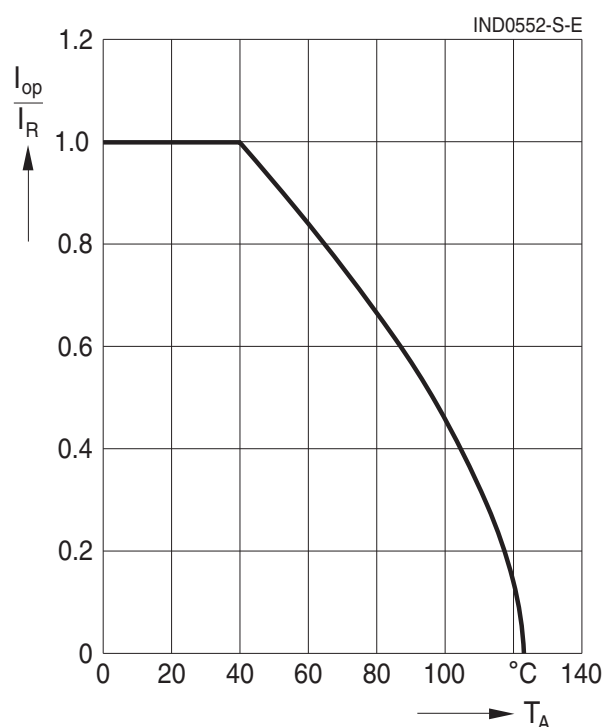
**Inductance  $L$  versus DC load current  $I_{DC}$**   
 measured with LCR meter Agilent 4284A, typical values at +20 °C



**Q factor versus frequency  $f$**   
 measured with impedance analyzer Agilent 4294A, typical values at +20 °C



**Current derating  $I_{op}/I_R$  versus ambient temperature  $T_A$**   
 (rated temperature  $T_R = +40$  °C)



## Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.  
Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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Release 2018-10